

<HVIC>

M81776FP

600V HIGH VOLTAGE HALF BRIDGE DRIVER

DESCRIPTION

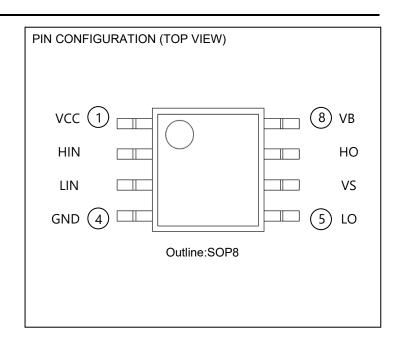
M81776FP is high voltage Power MOSFET and IGBT gate driver for half bridge applications.

FEATURES

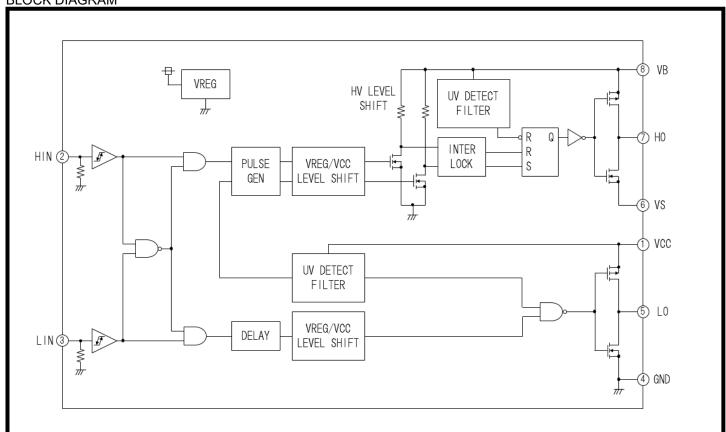
- Floating Supply Voltage · · · · · 600V
 Output Current · · · · · · · +200mA/-350mA
- Half Bridge Driver
- Protect supply voltage drop
- SOP-8 Package

APPLICATIONS

MOSFET and IGBT module driver.



BLOCK DIAGRAM



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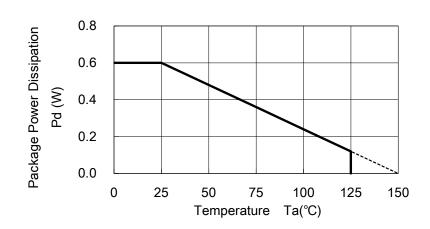
Symbol	Parameter	Test conditions	Ratings	Unit
V _B	High Side Floating Supply Absolute Voltage		- 0.5 ~ 624	V
Vs	High Side Floating Supply Offset Voltage		V _B - 24 ~ V _B + 0.5	V
V _{BS}	High Side Floating Supply Voltage	V _{BS} = V _B - V _S	- 0.5 ~ 24	V
V _{HO}	High Side Output Voltage		$V_S - 0.5 \sim V_B + 0.5$	V
Vcc	Low Side Fixed Supply Voltage		- 0.5 ~ 24	V
V _{LO}	Low Side Output Voltage		- 0.5 ~ Vcc + 0.5	V
V _{IN}	Logic Input Voltage	HIN,LIN Terminal	- 0.5 ~ Vcc + 0.5	V
Pd	Package Power Dissipation	Ta = 25°C ,On Board	0.6	W
Κθ	Linear Derating Factor	Ta > 25°C ,On Board	4.8	mW/°C
Rth(j-c)	Junction-Case Thermal Resistance		50	°C/W
Tj	Junction Temperature		- 40 ~ 150	°C
Topr	Operation Temperature		- 40 ~ 125	°C
Tstg	Storage Temperature	On Board	- 40 ~ 150	°C
TL	Solder Reflow Condition	Pb-free	255:10s, max 260	°C

RECOMMENDED OPERATING CONDITIONS

Cumbal	Parameter	Test conditions		Unit			
Symbol	Farameter	rest conditions	Min.	Тур.	Max.	Offic	
V _B	High Side Floating Supply Absolute Voltage		Vs + 10	_	Vs + 20	V	
Vs	High Side Floating Supply Offset Voltage		0	_	500	V	
V _{BS}	High Side Floating Supply Voltage	$V_{BS} = V_B - V_S$	10	_	20	V	
V _{но}	High Side Output Voltage		Vs	_	V _B	V	
Vcc	Low Side Fixed Supply Voltage		10	_	20	V	
V _{LO}	Low Side Output Voltage		0		Vcc	V	
V_{IN}	Logic Input Voltage	HIN,LIN Terminal	0	_	Vcc	V	

Note: For proper operation, the device should be used within the recommended conditions

THERMAL DERATING FACTOR CHARACTERISTIC (MAXIMUM RATING)

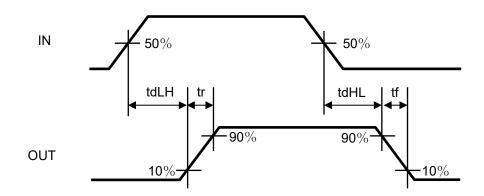


ELECTRICAL CHARACTERISTICS (Ta=25°C, VCC=VBS (=VB-VS)=15V, unless otherwise specified)

Symbol	Dorometer	Toot conditions	Limits			1.1
Symbol	Parameter	Test conditions	Min.	Typ.*	Max.	Unit
I _{FS}	Floating Supply Leakage Current	$V_B = V_S = 600V$	_	_	1.0	uA
I _{BS}	V _{BS} Standby Current	HIN = LIN = 0V	_	0.2	0.5	mA
I _{cc}	V _{CC} Standby Current	HIN = LIN = 0V	0.2	0.5	1.0	mA
V _{OH}	High Level Output Voltage	I _O = -20mA HO,LO Terminal	13.6	14.2	_	V
V _{OL}	Low Level Output Voltage	I _O = 20mA HO,LO Terminal	_	0.3	0.6	V
V _{IH}	High Level Input Threshold Voltage	HIN,LIN Terminal	2.7	_	_	V
V_{IL}	Low Level Input Threshold Voltage	HIN,LIN Terminal	_	_	0.8	V
I _{IH}	High Level Input Bias Current	V _{IN} = 5V	_	25	100	uA
I _{IL}	Low Level Input Bias Current	V _{IN} = 0V	_	_	2	uA
V_{BSuvr}	V _{BS} Supply UV Reset Voltage		7.0	8.4	9.8	V
V_{BSuvt}	V _{BS} Supply UV Trip Voltage		6.5	7.85	9.0	V
V_{BSuvh}	V _{BS} Supply UV Hysteresis Voltage		0.3	0.55	_	V
t _{VBSuv}	V _{BS} Supply UV Filter Time		_	7.5	_	us
V_{CCuvr}	V _{CC} Supply UV Reset Voltage		7.0	8.4	9.8	V
V_{CCuvt}	V _{CC} Supply UV Trip Voltage		6.5	7.85	9.0	V
V_{CCuvh}	V _{CC} Supply UV Hysteresis Voltage		0.3	0.55	_	V
t _{VCCuv}	V _{CC} Supply UV Filter Time		_	7.5	_	us
I _{OH}	Output High Level Short Circuit Pulsed Current	V _O = 0V, V _{IN} = 5V, PW < 10ms	120	200	_	mA
I _{OL}	Output Low Level Short Circuit Pulsed Current	V _O = 15V, V _{IN} = 0V, PW < 10ms	250	350	_	mA
R _{OH}	Output High Level On Resistance	$I_{O} = -20 \text{mA}, R_{OH} = (V_{OH} - V_{O}) / I_{O}$	_	40	70	Ω
R _{OL}	Output Low Level On Resistance	$I_0 = 20 \text{mA}, R_{OL} = V_{OL} / I_0$	_	15	30	Ω
t _{dLH} (HO)	High Side Turn-On Propagation Delay	CL = 1000pF between HO - Vs	_	150	300	ns
t _{dHL} (HO)	High Side Turn-Off Propagation Delay	CL = 1000pF between HO - V _S	_	130	230	ns
t _{rH}	High Side Turn-On Rise Time	CL = 1000pF between HO - V _S	_	130	220	ns
t _{fH}	High Side Turn-Off Fall Time	CL = 1000pF between HO - Vs	_	50	80	ns
t _{dLH} (LO)	Low Side Turn-On Propagation Delay	CL = 1000pF between LO - GND	_	150	300	ns
t _{dHL} (LO)	Low Side Turn-Off Propagation Delay	CL = 1000pF between LO - GND	_	130	230	ns
t _{rL}	Low Side Turn-On Rise Time	CL = 1000pF between LO - GND	_	130	220	ns
t _{fL}	Low Side Turn-Off Fall Time	CL = 1000pF between LO - GND		50	80	ns
DtdLH	Turn-On Propagation Delay Matching	tdLH(HO) - tdLH(LO)	_	0	30	ns
DtdHL	Turn-Off Propagation Delay Matching	tdHL(HO) - tdHL(LO)	_	0	30	ns

^{*} Typ is not specified

INPUT/OUTPUT TIMING DIAGRAM



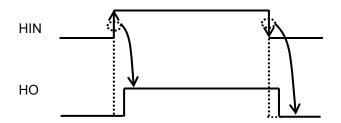
FUNCTION TABLE (X:H or L)

HIN	LIN	V _{BS} UV	VccUV	НО	LO	Behavioral state
H→L	L	Н	Н	L	L	HO = L, LO = L
H→L	Н	Н	Н	L	Н	LO = H
L→H	L	Н	Н	Н	L	HO = H
L→H	Н	Н	Н	L	L	HO = L, LO = L
Х	L	L	Н	L	L	LO=L,HO=L when V _{BS} UV is detected
X	Н	L	Н	L	Н	LO=H,HO=L when V _{BS} UV is detected
H→L	Х	Н	L	L	L	LO=L,HO=L when VccUV is detected
L→H	Х	Н	L	L	L	LO=L,HO=L when VccUV is detected

Note1: "L" state of V_{BS} UV, V_{CC} UV means that V_{CC} (V_{BS}) Supply become under UV trip voltage.

Note2 : In the case of both input signals (HIN and LIN) are "H", output signals (HO and LO) become "L". Note3 : X(HIN):L→H or H→L X(LIN):H or L

Note3: Output Signal (HO) is triggered by the edge of input signal.

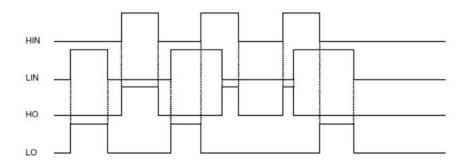


FUNCTION TIMING DIAGRAM

600V HIGH VOLTAGE HALF BRIDGE DRIVER

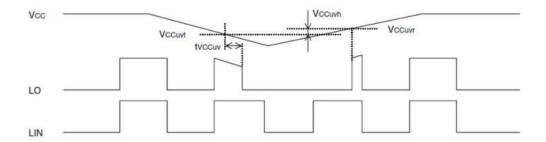
1. Input/Output Timing Diagram

High Active (When input signal (HIN or LIN) is "H", then output signal (HO or LO) is "H".) In the case of both input signal (HIN and LIN) are "H", output signals (HO and LO) become "L".

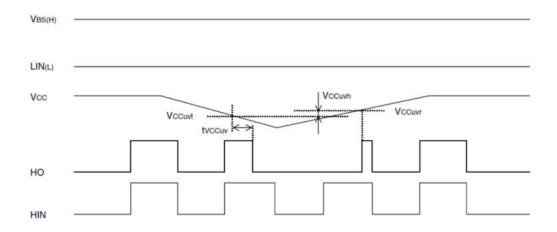


2. Vcc (VBS) Supply Under Voltage (UV) Lockout Timing Diagram

If V_{CC} supply voltage drops below UV trip voltage (V_{CC}uvt) for V_{CC} supply UV filter time, LO output signal is shut down. And then, if V_{CC} supply voltage rises over UV reset voltage, LO will return to the usual operation mode.



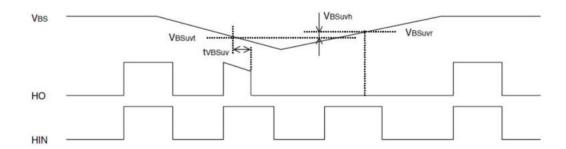
If V_{CC} supply voltage drops below UV trip voltage (V_{CC} uvt) for V_{CC} supply UV filter time, HO output signal is shut down. And then, if V_{CC} supply voltage rises over UV reset voltage, HO will return to the usual operation mode.



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If V_{BS} supply voltage drops below UV trip voltage (V_{BS} uvt) for V_{BS} supply UV filter time, HO output signal is shut down. And then, if V_{BS} supply voltage rises over UV reset voltage, HO will respond to the next active HIN signal($L\rightarrow H$).



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NOTES

1) Allowable supply voltage transient

It is recommended to supply V_{CC} firstly and supply V_{BS} secondly. In the case of shutting off supply voltage, please shut off V_{BS} firstly and shut off V_{CC} secondly.

When applying VCC and VBS, power supply should be applied slowly.

If it rises rapidly, output signal (HO or LO) may be malfunction.

2) Supply voltage start up or restart after shut down

If V_{CC} supply is less than 10V(outside of RECOMMENDED OPERATING CONDITIONS), there is some possibility that output does not change in response to input.

Please evaluate carefully about supply start up or restart after shut down in your application systems.

3) V_B supply voltage

Please use V_B supply voltage within RECOMMENDED OPERATING CONDITIONS

 $(V_S + 10V < V_B < V_S + 20V : V_S = 0V minimum)$

If V_B supply voltage is used on the other conditions, output signal HO may be malfunction.

Please evaluate carefully about V_B supply voltage in your application systems.

4) Inter-terminal processing

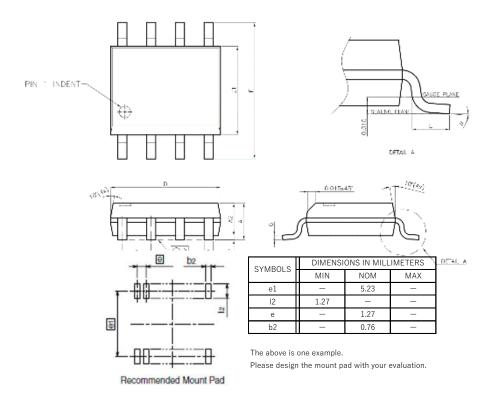
In this product, the terminal of the low voltage part and the high voltage part are adjacent (No.5:V_{CC}, No.6:V_S). There may be cases where there is insufficient insulation clearance distance between the pins.

Please use such as coating between the terminals.

ENVIRONMENTAL CONSCIOUSNESS

M81776FP is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU+(EU)2015/863.

PACKAGE OUTLINE



	DIMENSIONS IN WILLIMETERS						
SYMBOLS	MIN	MCM	MAX				
A	1.47	1.60	1.73				
A1	0.10		0.25				
A2		1.45					
ь	0.35	0.41	0.51				
C	0.19	0.20	0.25				
D	4.90	4.85	4.95				
E	5.80	6.00	6.20				
E1	3.80	3.90	4.00				
е	_	1.27					
L	0.40	0.71	1.27				
У			0.076				
	00		8,				

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Main Revision for this Edition

		Revision		
Rev.	Date	Pages Points		
A	2 Apr. 2018	- rayes	New	
	_ / \pi. 2010			
В	28 Apr. 2021	-	Delete "PRELIMINARY".	
			Update format.	
]			

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